

Technical Data Data Sheet N1217, Rev. B **Green Products**

306CNQ200 SCHOTTKY RECTIFIER

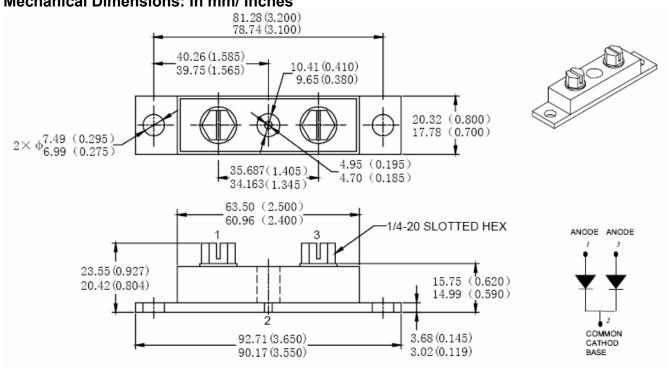
Applications:

- High current switching power supply Plating power supply Free-Wheeling diodes
- Reverse battery protection Converters UPS System Welding

Features:

- 175 °C T_J operation
- · Center tap module
- High purity, high temperature epoxy encapsulation for enhanced mechanical strength and moisture resistance
- Low forward voltage drop
- High frequency operation
- Guard ring for enhanced ruggedness and long term reliability
- This is a Pb Free Device
- All SMC parts are traceable to the wafer lot
- Additional testing can be offered upon request

Mechanical Dimensions: In mm/ Inches



PRM4 (Non-Isolated)

MARKING, MOLDING RESIN

Marking for 306CNQ200, 1st row SS YYWWL, 2nd row 306CNQ200 Where YY is the manufacture year WW is the manufacture week code L is the wafer's Lot Number Molding resin

Molding resin Epoxy resin UL:94V-0

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Maximum Ratings:

Characteristics	Symbol	Condition	Max.		Units
Peak Inverse Voltage	V_{RWM}	-	200		V
Max. Average Forward	I _{F(AV)}	50% duty cycle @T _C =121°C,	150	per leg	Α
Current		rectangular wave form	300	per device	
Max. Peak One Cycle Non- Repetitive Surge Current (per leg)	I _{FSM}	8.3 ms, half Sine pulse	3840		А

Electrical Characteristics:

Characteristics	Symbol	Condition	Max.	Units
Max. Forward Voltage Drop (per leg) *	V_{F1}	@ 150A, Pulse, T _J = 25 °C	0.86	V
		@ 300A, Pulse, T _J = 25 °C	1.03	
	V_{F2}	@ 150A, Pulse, T _J = 125 °C	0.76	V
		@ 300A, Pulse, T _J = 125 °C	0.86	
Max. Reverse Current (per	I _{R1}	$@V_R = \text{rated } V_R T_J = 25 ^{\circ}\text{C}$	10	mA
leg) *	I_{R2}	$@V_R = \text{rated } V_R T_J = 125 ^{\circ}\text{C}$	90	mΑ
Max. Junction Capacitance	Ст	$@V_R = 5V, T_C = 25 ^{\circ}C$	3500	pF
(per leg)		f _{SIG} = 1MHz		
Typical Series Inductance	L _S	Measured lead to lead 5 mm	7.0	nH
(per leg)	∟ S	from package body	7.0	
Max. Voltage Rate of Change	dv/dt	-	10,000	V/μs
Insulation Voltage	V_{RMS}	-	1000	V

^{*} Pulse Width < 300µs, Duty Cycle <2%

Thermal-Mechanical Specifications:

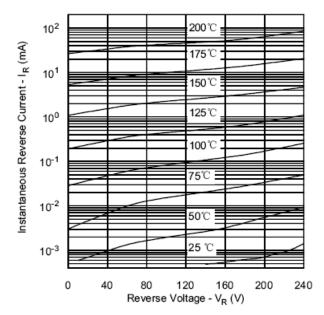
Characteristics	Symbol	Condition	Specifi	Units			
Max. Junction Temperature	T_J	-	-55 to	°C			
Max. Storage Temperature	T_{stg}	-	-55 to	°C			
Maximum Thermal Resistance Junction to Case (per leg)	$R_{ heta JC}$	DC operation	040		°C/W		
Maximum Thermal Resistance Junction to Case (per package)	$R_{ heta JC}$	DC operation	0.20		°C/W		
Typical Thermal Resistance, case to Heat Sink	$R_{ heta cs}$	Mounting surface, smooth and greased	0.10		°C/W		
Mounting Torque	Тм	-	Mounting Torque Terminal Torque	24(min) 35(max) 35(min) 46(max)	Kg-cm		
Approximate Weight	wt	-	79		g		
Case Style	PRM4 Non-Isolated						

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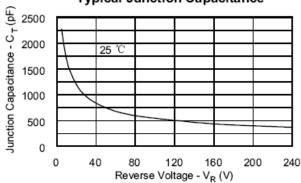
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Typical Forward Characteristics 10² 200°C 175℃ Instantaneous Forward Current - I F (A) 10¹ 125°C 10⁰ 25℃ 10⁻¹ 0.0 0.2 0.4 0.6 1.0 Forward Voltage Drop - V_F (V)

Typical Reverse Characteristics



Typical Junction Capacitance



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